

November 2013



FCI25N60N N-Channel SupreMOS[®] MOSFET 600 V, 25 A, 125 mΩ

Features

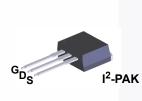
- R_{DS(on)} = 107 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 12.5 A
- Ultra Low Gate Charge (Typ. Q_g = 57 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 262 pF)
- 100% Avalanche Tested
- RoHS Compliant

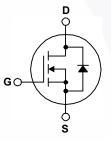
Application

- Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

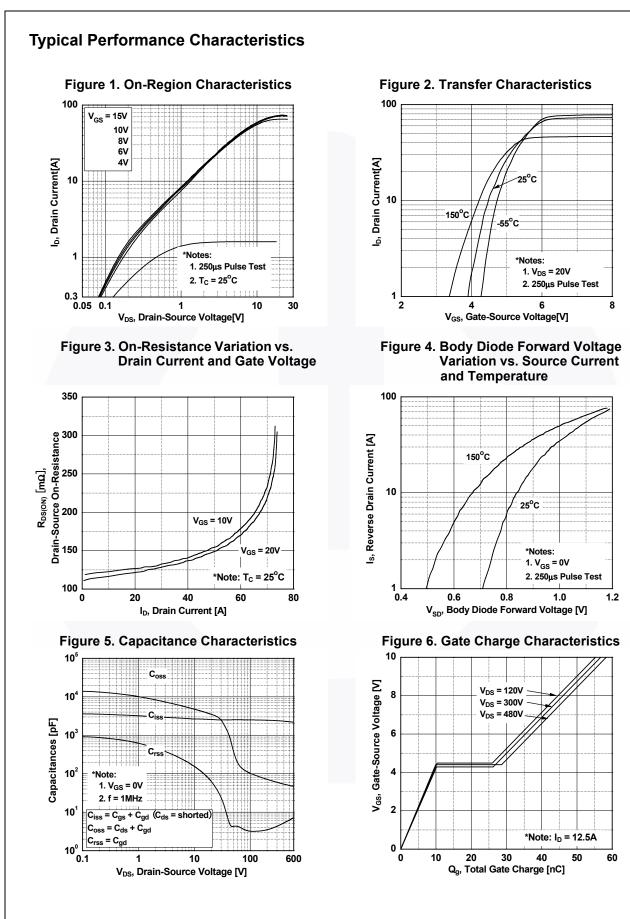
| Symbol | Parameter | | | FCI25N60N_F102 | Unit | |
|-----------------------------------|---|--|---------|----------------|------|--|
| V _{DSS} | Drain to Source Voltage | | | 600 | V | |
| V _{GSS} | Gate to Source Voltage | | | ±30 | V | |
| I _D | Drain Current | - Continuous (T _C = 25 ^o C) | | 25 | A | |
| | | - Continuous (T _C = 100 ^o C) | | 16 | | |
| I _{DM} | Drain Current | - Pulsed (N | Note 1) | 75 | А | |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | | 861 | mJ | |
| I _{AR} | Avalanche Current (Note 1) | | | 8.3 | А | |
| E _{AR} | Repetitive Avalanche Energy | | Note 1) | 2.2 | mJ | |
| dv/dt | MOSFET dv/dt | | | 100 | V/ns | |
| | Peak Diode Recovery dv/ | 15 | | | | |
| P _D | Power Dissipation | $(T_{\rm C} = 25^{\rm o}{\rm C})$ | | 216 | W | |
| | | - Derate Above 25°C | | 1.72 | W/ºC | |
| T _J , T _{STG} | Operating and Storage Temperature Range | | | -55 to +150 | °C | |
| TL | Maximum Lead Temperat | ture for Soldering, 1/8" from Case for 5 Secon | ds | 300 | °C | |

Thermal Characteristics

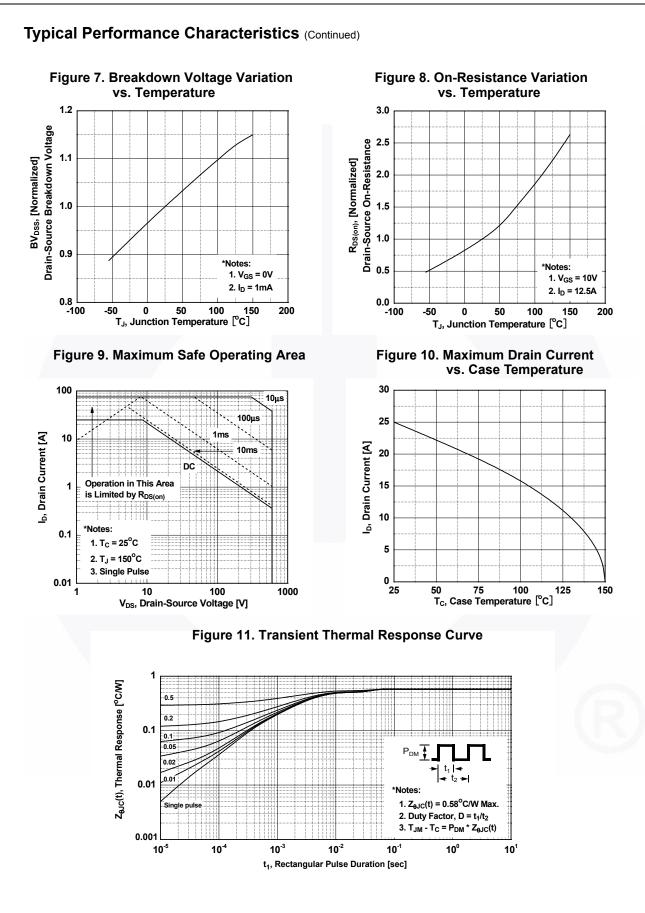
| Symbol | Parameter | FCI25N60N_F102 | Unit | |
|-----------------------|--|----------------|------|--|
| $R_{	extsf{	heta}JC}$ | θJC Thermal Resistance, Junction to Case, Max. | | °C/W | |
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient, Max. | 62.5 | 0/00 | |

| Part Nun | Part Number Top Mark Pa | | Package | Packing Meth | od Reel Size | Тар | e Width | Qua | ntity | |
|---|--|---|---------------------|---|-------------------|------|----------|-------|----------|--|
| FCI25N60N | L_F102 | FCI25N60N | I ² -PAK | Tube | N/A | | N/A | | 50 units | |
| Electrica | l Char | acteristics T _c =: | 250C upload | othonwice noted | I | | | 1 | | |
| Symbol | | Parameter | 25°C unless | Test Con | ditions | Min. | Тур. | Max. | Uni | |
| Off Charac | toristics | | | | | | .,,,,, | maxi | • | |
| | | | taga | 1 = 1 = 0 | $V = 25^{\circ}C$ | 600 | - | - | V | |
| BV _{DSS} ΔBV _{DSS} | Drain to Source Breakdown Voltage Breakdown Voltage Temperature | | • | $I_{\rm D}$ = 1 mA, $V_{\rm GS}$ = 0 V, $T_{\rm J}$ = 25°C | | 000 | - | - | | |
| $/\Delta T_J$ | Coefficie | | | $I_D = 1 \text{ mA}$, Referenced to 25° C | | - | 0.74 | - | V/ºC | |
| I _{DSS} | Zero Ga | ro Gate Voltage Drain Current | | V _{DS} = 480 V, V _{GS} = 0 V | | - | - | 10 | μA | |
| 033 | | 5 | | V _{DS} = 480 V, T _J = 1 | | - | - | 100 | · · | |
| I _{GSS} | Gate to | Body Leakage Current | | $V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} =$ | = 0 V | - | - | ±100 | nA | |
| On Charac | teristics | ; | | | | | | | | |
| V _{GS(th)} | Gate Th | reshold Voltage | | V _{GS} = V _{DS} , I _D = 25 | 0 μΑ | 2.0 | - | 4.0 | V | |
| R _{DS(on)} | Static Dr | ain to Source On Resis | tance | V _{GS} = 10 V, I _D = 12 | 2.5 A | - | 0.107 | 0.125 | Ω | |
| 9 _{FS} | Forward | Transconductance | | V _{DS} = 20 V, I _D = 12 | 2.5 A | - | | - | S | |
| Dynamic C | haracte | ristics | | | | | | | | |
| C _{iss} | | pacitance | | | | | 2520 | 3352 | pF | |
| C _{oss} | | Capacitance | | V _{DS} = 100 V, V _{GS} = | = 0 V, | _ | 103 | 137 | pF | |
| C _{rss} | | Transfer Capacitance | | f = 1 MHz | | _ | 3.2 | 5 | pF | |
| C _{oss} | | Capacitance | | V _{DS} = 380 V, V _{GS} : | = 0 V. f = 1 MHz | - | 55 | - | pF | |
| C _{oss(eff.)} | | ective Output Capacitance | | $V_{\rm DS} = 0 \text{ V to } 480 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V}$ | | - | 262 | _ | pF | |
| Q _{g(tot)} | | te Charge at 10V | | | | | 57 | 74 | nC | |
| Q _{gs} | | Source Gate Charge | | V _{DS} = 380 V, I _D = 12.5 A, V _{GS} = 10 V (Note 4) | | - | 10 | - | nC | |
| Q _{gd} | Gate to I | Drain "Miller" Charge | | | | - | 18 | - | nC | |
| ESR | Equivale | nt Series Resistance (C | G-S) | f = 1 MHz | | - | 1 | - | Ω | |
| Switching | Charact | eristics | | | | | | | | |
| • | | Delay Time | | | | | 21 | 52 | ns | |
| t _{d(on)} | | Rise Time | | V _{DD} = 380 V, I _D = 12.5 A, V _{GS} = 10 V, R _G = 4.7 Ω | | | 21 | 54 | ns | |
| t _r | | Delay Time | | | | -7- | 68 | 146 | ns | |
| t _{d(off)} t _f | | Fall Time | | | (Note 4) | - | 5 | 20 | ns | |
| | | | | | (1010 4) | | U | 20 | 110 | |
| | | e Characteristics | . <u> </u> | <u> </u> | | | | 0.5 | | |
| l _s | | n Continuous Drain to S | | | | - | - | 25 | A | |
| I _{SM} | | n Pulsed Drain to Sourc Source Diode Forward ' | | | E A | - | - | 75 | A V | |
| V _{SD} | | | J | $V_{GS} = 0 V, I_{SD} = 12$ | | - | - | 1.2 | - | |
| t _{rr} | | Recovery Time Recovery Charge | | V _{GS} = 0 V, I _{SD} = 12 dI _F /dt = 100 A/μs | 5 A, | - | 370 7 | - | ns µC | |
| Q _{rr} lotes: | Reverse | | | | | | I | | μΟ | |
| | = 25 Ω, starting | imited by maximum junction ter g T _J = 25°C. _{DD} \leq 380 V, starting T _J = 25°C. | nperature. | | | | | | | |

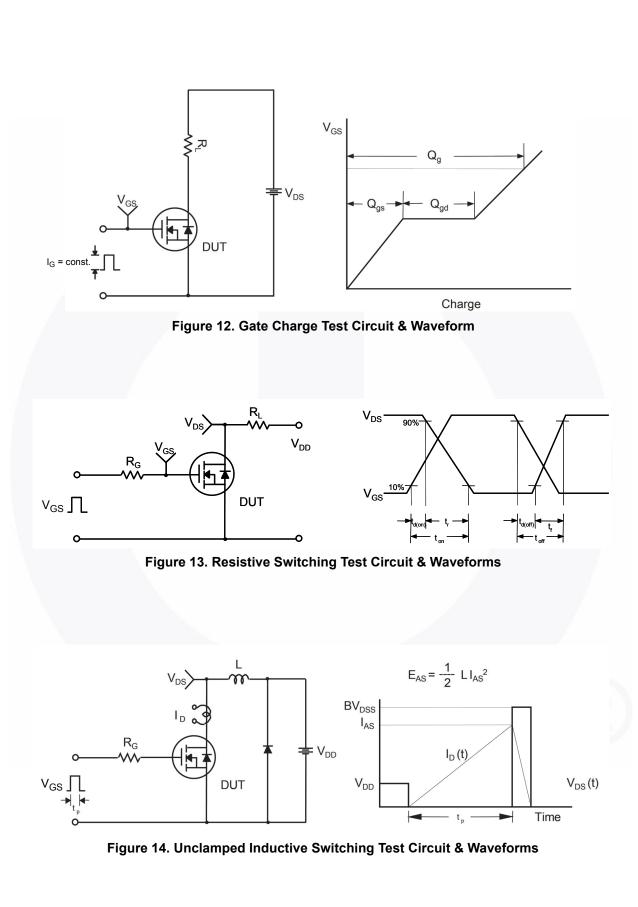
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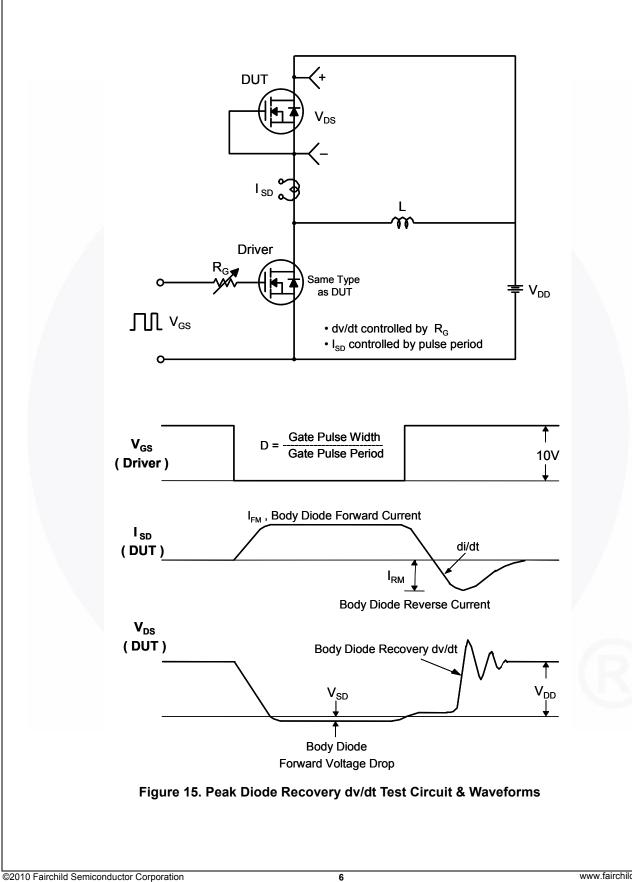


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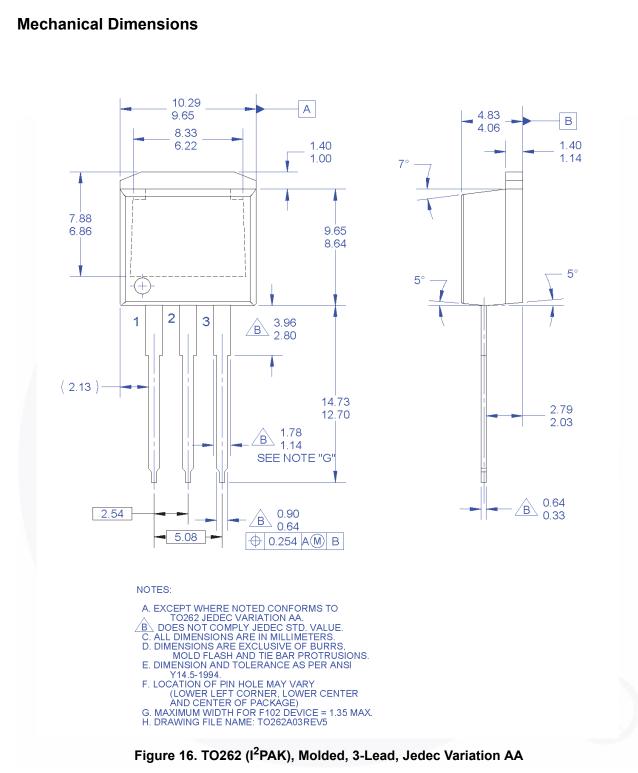


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FCI25N60N Rev. C1



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